

TELANGANA STATE COUNCIL OF HIGHER EDUCATION : HYDERABAD

TSECET– 2015 ADMISSIONS

From

**Convenor, TSECET- 2015(Admissions),
Sanketika Vidya Bhavan,
Masabtank,
Hyderabad – 500 028.**

To

**The Principals of all
Private Engineering
Colleges of Telangana
State.**

Lr No. TSECET– 2015/ADMNS/CONVENOR/15, Dated: 10-08- 2015.

Sir,

**Sub: - TSECET– 2015 Engineering Admissions (Lateral Entry)–
Communication of guidelines to fill the left over vacancies during
Institutional Spot Admissions – Reg.**

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The Principals of the Private Engineering colleges in Telangana state are informed that TSECET-2015 Admissions are completed by 09-08- 2015 and the students were instructed to report by 10-08-2015. The leftover vacancies branch wise at the end of Final Phase allotments are placed in the website <https://tsecetd.nic.in> . You are requested to fill up these vacancies along with not-reported/cancellations done at college as well as left over seats by conducting Institutional Spot Admissions on or before 15-08- 2015.

1. The Convenor did not collect the original certificates of the candidate at the time of granting the provisional admission. Hence, the Principals are requested to thoroughly verify and collect all the original certificates and retain them till the candidate completes the course.
2. List of allotted candidates and vacancy position after conclusion of the web counseling are placed in the web.
3. Candidates have been asked to report at the respective institutions on or before 10-08-2015 without fail. Seats left unfilled at the end of Final Phase are indicated in the vacancy position placed in web site <https://tsecetd.nic.in>. Vacancy of concerned college can be downloaded through college login in the department site.

How to arrive at the vacancy position?

- A. Unfilled vacancies at the end of phase-2 are placed in respective college login portals of <https://tsecetd.nic.in>.
- B. Deduct the number of vacancies after making adjustments as directed in Special Guidelines [Case 1 and Case 2].
- C. Deduct the number of vacancies filled due to re-allotment from one branch to another branch (internal sliding) and add the resultant vacancies.
- D. Add dropouts (joined and discontinued).
- E. Add not reported cases.
- F. Add cancellations.

The final vacancy for spot admission shall be arrived by considering A to F above.

**Total vacancies for Institutional spot admissions = Unfilled seats at the end of final phase +
Number not reported from the list of allotted
candidates + Number reported but cancelled
after Final phase.**

Please comply the following scrupulously:

1. Issue a Notification in a Daily News paper indicating the date of Spot Admissions.
2. Eligibility Criteria:
 - a. Candidates who have not taken admission so far are only eligible. Candidates shall not be allowed for spot admission without original certificates.
 - b. The vacancies are to be filled first with those qualified in TSECET-2015 and possessing 44.5% and above (for OC) and 39.5% and above for (BC/SC/ST) in the relevant Diploma/B.Sc. Examination.
 - c. If the vacancies are still left, Candidates who have passed Diploma/B.Sc. Examination with 44.5 % and above (OC), 39.5% and above (BC/SC/ST) are to be considered.
 - d. Candidates who satisfy the definition of Local/Non-Local shall alone be granted admission.
 - e. Candidates whose diploma is from other state but either of the parents resided for a period of 10 years in Telangana /A.P state are eligible for Spot Admissions.
 - f. Candidates possessing Diploma Certificates other than those issued by the State Board of Technical Education, Telangana /A.P shall be asked to get the equivalency certificate from Telangana SBTET, HYDERABAD before granting admission.
 - g. Eligibility master in the annexure enclosed shall be followed for candidates qualified in TSECET.
 - h. For candidates not qualified in TSECET and belonging to Diploma in Electronics and Instrumentation or Diploma in Applied Electronics and Instrumentation shall not be offered ECE branch at degree level as such facility is not extended to qualified candidates as per the Government Orders. For other diploma holders such restriction does not exist.

3. Certificates to be Verified:

- a. Diploma/B.Sc. Original.
- b. Marks Memorandum of 3 Years
- c. Study Certificate.
- d. Residence Certificate.
- e. TSECET-15 Rank Card, if qualified
- f. TSECET -15 Hall Ticket , if qualified
- g. Caste Certificate.

4. After conclusion of Admissions at Convener's level, certain representations are received from the candidates and also the managements of the Private Engineering colleges in the state regarding Re-allotment/re-adjustment of the candidates on the pretext that the Managements are unable to run certain courses due to lack of sufficient strength etc.
5. This matter is taken on a serious concern as it is grossly unfair to put the students in mental distress as well as denying the candidate of getting a seat in better opted college/course in counseling. The Convenor is forced to bring this matter to the notice of the TSCHE /University concerned/ Government to take suitable action on the college managements. However, in view of the hardship faced by the candidates, the following case-1 and case-2 of re-allotment are suggested.
6. Accordingly the managements who intend to reallocate/readjust/close the courses shall submit a letter of closure on an affidavit signed by authorized representative of the college and seek prior approval for such re-allotment/re-adjustment from the Convenor.
7. Accordingly, the Managements are requested to comply scrupulously with the following guidelines. Managements shall note that the Special Instructions now issued are applicable only in respect of candidates who are already allotted by the Convenor, but not for the candidates seeking fresh admissions or not allotted any seat during counselling.

Case-1: ALLOTMENT OF CANDIDATES TO ANOTHER ELIGIBLE BRANCH WITHIN THE SAME COLLEGE WHEN MANAGEMENT INTENDS TO CLOSE ONE BRANCH DUE TO INSUFFICIENT STRENGTH.

The Managements who are unable to run a particular course/courses shall seek prior approval as stated above and re-allot (slide) them into some other eligible branch in the same college, if the vacancies still exist. For this purpose, they should enclose a written consent of the candidate and the options[college / course] for

which the candidate intends to seek re-allotment / re-adjustment and list of such re-allotments shall be submitted in the following format to the Convenor along with spot admissions lists in person or by post.

This is not applicable to internal sliding of candidates from one branch to another branch when candidates exist in both branches and either of the branch is not closed.

H.T.No	Rank	Category	Allotted College Code	Allotted Course Code	Re-Allotted Course Code	Fee Exempted/ Fee Paid

Case-2: WHEN THE MANAGEMENT INTENDS TO TRANSFER ALL THE CANDIDATES TO ANOTHER COLLEGE/COLLEGES AND WISH TO CLOSE THE ADMISSIONS FOR 2015-16 IN ALL COURSES IN THE COLLEGE.

Certain representations are also received from the Managements that they are unable to run the college due to poor strength after final Phase of allotment and requested for Allotment of these candidates to some other college. In this connection, the college managements who intend to transfer these candidates have to contact the college/colleges to which the candidate are to be transferred and affect the transfer accordingly with the consent of Candidates and also producing No Objection Certificate (NOC) from both the colleges and submit the final list as per the following format for Verification along with spot admission lists .

H.T.No	Rank	Category	Allotted College Code	Allotted Course Code	Re-allotted College Code	Re-Allotted Course Code	Fee Exempted/ Fee Paid

PRINCIPALS / MANagements OF COLLEGES SHALL NOT CONTINUE ANY CANDIDATES WHO ARE NOT PRESENT IN THE CURRENT LIST OF ALLOTMENTS. THEY SHALL BE DIRECTED TO REPORT TO THE NEW INSTITUTION IMMEDIATELY.

Allotments/adjustments made as per cases 1 to 2 are eligible for fee reimbursement based on the candidate's eligibility for fee reimbursement already granted by the Convenor as per the existing rules. College managements shall verify the joining details entry before allowing such changes

and candidates figuring in the cancellation list shall not be entertained.

- i. All the candidates admitted under Spot Admissions have to pay the following Processing fee drawn in favour of Convenor, TSECET-2015 Admissions(Processing Fee). Single D.D. shall be drawn for all the candidates admitted in the institution. The D.D shall be enclosed to the Application to be submitted along with the list of candidates and relevant documents at the time of verification.

(A) TSECET-2015 Qualified Candidates : Rs 800/-

(B) TSECET-2015 Not Qualified Candidates : Rs 1050/-

Principals shall make sure of the eligibility criteria prescribed for admission before granting admission to the candidates.

- ii. **The details of candidates such as Cancellations, fresh admissions made shall be uploaded in the web portal. The detailed instructions of operation of this web portal will be made available by 20-08-2015 and last date for uploading the details in the website <https://tsecetd.nic.in> through College Login, for ratification before 25-08-2015.**
- iii. **The following shall be kept ready for verification and ratification on a specified date which will be intimated in due course.**
 - a) **Original certificates and documents collected from the candidates.**
 - b) **DD drawn in favour of the Convenor, TSECET-2015 Admissions (Processing Fee) payable at Hyderabad for the amount collected from the candidates towards processing fee as mentioned above.**
 - c) **NO CANDIDATE SHALL BE ADMITTED IN SPOT ADMISSIONS WITHOUT ORIGINAL CERTIFICATES.**

d) Candidates not uploaded in web portal and not satisfying the eligibility requirements for admission will not be entertained for ratification.

The following are the dates to be followed by the Principals in connection with the Spot Admissions.

Last date for Conducting Spot Admissions : 15-08-2015.

Note: The Principals are requested to submit the following along with Spot Admission List for ratification.

- a) Newspaper copy of notification for conducting Spot Admissions.
- b) Xerox copies of all original certificates of the candidates collected during spot admissions.

Please Note that the Students admitted through Spot Admissions (i.e.) leftover seats are not eligible for Tuition Fee Reimbursement.

Candidates who have passed the Three year B.Sc Degree Examination with Mathematics as one of the subject in the group combination from a recognized University in the State or its equivalent examination are only eligible for entry into the relevant courses of Engineering as per G.O. in vogue. All Diploma Holders are to be considered first for available vacancies and thereafter BSc passed candidates for left over vacancies in the Institutional Spot admission.

NOTE: These guidelines are not applicable for University Engineering / Pharmacy colleges and Self Financed programmes of Universities.

**Sd/- CONVENOR
TSECET – 2015 (Admissions)**

List of items to be downloaded from the web: <http://tsecetd.nic.in> for spot admissions:

1. List of admitted candidates of the college.
2. List of left over vacancies.
3. Proforma for submission of Institutional Spot Admission for ratification.

TSECET – 2015 SPOT ADMISSIONS

NAME OF THE INSTITUTION :

COLLEGE CODE [TSECET COUNSELING CODE]:

BRANCH WISE VACANCIES GIVEN TO COLLEGE:

S.NO.	BRANCH	NUMBER OF VACANCIES

Example : CBIT - EEE – OU – SC - GEN

DETAILS OF NOT REPORTED / CANCELLATIONS DONE AT COLLEGE :

	RANK	HTNO	NAME	* DETAILS OF VACANCY
D-1				
D-2				
D-3				
D-4				
D-5				

DETAILS OF SLIDINGS MADE :

RANK	HTNO	CATEGORY	NAME	* PREVIOUS ALLOTMENT	* CURRENT ALLOTMENT

TSECET – 2015 SPOT ADMISSIONS (CONVENOR SEATS)

NAME OF THE INSTITUTION:

PAGE : 2

DETAILS OF FRESH ADMISSIONS MADE :

S.No.	RANK	HT.NO	DIPLOMA BRANCH/ B.Sc. GROUP	TSECET EXAMINA TION APPEARE D	NAME	RESERVATION CATEGORY	% OF MARKS	DETAILS OF ALLOTMENT IN COLLEGE CODE- COURSE CODE-LOCAL AREA-CATEGORY-SEX FORMAT

* Details of allotment shall include college code, course code, local area, category and sex as given by the Convenor during admissions.

* Enclose proof of Diploma Certificate /B.Sc Degree certificate for Ratification.

Example : CBIT - EEE – OU – SC - GEN

DATE

PRINCIPAL

COURSE ELIGIBILITY MASTER for TSECET-2015

dip_br_code	dip_branch_name	TSECET_subject	engg_elig_branch
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	ECE	CSE
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	ECE	ECE
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	ECE	ECS
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	ECE	ETM
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	ECE	INF
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	ECE	ETC
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	EIE	AEI
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	EIE	CSE
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	EIE	EIE
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	EIE	ICE
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	EIE	INF
AEI	APPLIED ELECTRONICS AND INSTRUMENTATION	EIE	IST
AUT	AUTOMOBILE ENGINEERING	MEC	ANE
AUT	AUTOMOBILE ENGINEERING	MEC	ASE
AUT	AUTOMOBILE ENGINEERING	MEC	AUT
AUT	AUTOMOBILE ENGINEERING	MEC	CSE
AUT	AUTOMOBILE ENGINEERING	MEC	INF
AUT	AUTOMOBILE ENGINEERING	MEC	IPE
AUT	AUTOMOBILE ENGINEERING	MEC	MCT
AUT	AUTOMOBILE ENGINEERING	MEC	MEC
AUT	AUTOMOBILE ENGINEERING	MEC	NMA
BIO	BIOTECHNOLOGY	BIO	BIO
BIO	BIOTECHNOLOGY	BIO	CSE
BIO	BIOTECHNOLOGY	BIO	INF
BME	BIO-MEDICAL ENGINEERING, SDBME	ECE	BME
BME	BIO-MEDICAL ENGINEERING, SDBME	ECE	CSE
BME	BIO-MEDICAL ENGINEERING, SDBME	ECE	ECE
BME	BIO-MEDICAL ENGINEERING, SDBME	ECE	ECS
BME	BIO-MEDICAL ENGINEERING, SDBME	ECE	ETM
BME	BIO-MEDICAL ENGINEERING, SDBME	ECE	INF
BME	BIO-MEDICAL ENGINEERING, SDBME	ECE	ETC
BSC	BSC(Mathematics)	MPC	PHM
CCT	CIVIL ENGINEERING (CONSTRUCTION TECHNOLOGY)	CIV	CEE
CCT	CIVIL ENGINEERING (CONSTRUCTION TECHNOLOGY)	CIV	CIV
CCT	CIVIL ENGINEERING (CONSTRUCTION TECHNOLOGY)	CIV	CSE
CCT	CIVIL ENGINEERING (CONSTRUCTION TECHNOLOGY)	CIV	INF
CCT	CIVIL ENGINEERING (CONSTRUCTION TECHNOLOGY)	CIV	GIN
CER	CERAMIC TECHNOLOGY(3 1/2 YR)	CER	CER
CER	CERAMIC TECHNOLOGY(3 1/2 YR)	CER	CSE
CER	CERAMIC TECHNOLOGY(3 1/2 YR)	CER	INF
CER	CERAMIC TECHNOLOGY(3 1/2 YR)	CHE	CHE
CER	CERAMIC TECHNOLOGY(3 1/2 YR)	CHE	CPE
CER	CERAMIC TECHNOLOGY(3 1/2 YR)	CHE	CSE
CER	CERAMIC TECHNOLOGY(3 1/2 YR)	CHE	INF
CHE	CHEMICAL ENGINEERING (3 1/2 YR)	BIO	BIO
CHE	CHEMICAL ENGINEERING (3 1/2 YR)	BIO	CSE
CHE	CHEMICAL ENGINEERING (3 1/2 YR)	BIO	INF

CHE	CHEMICAL ENGINEERING (3 1/2 YR)	CHE	CHE
CHE	CHEMICAL ENGINEERING (3 1/2 YR)	CHE	CPE
CHE	CHEMICAL ENGINEERING (3 1/2 YR)	CHE	CSE
CHE	CHEMICAL ENGINEERING (3 1/2 YR)	CHE	INF
CHE	CHEMICAL ENGINEERING (3 1/2 YR)	CHE	PET
CIV	CIVIL ENGINEERING	CIV	CEE
CIV	CIVIL ENGINEERING	CIV	CIV
CIV	CIVIL ENGINEERING	CIV	CSE
CIV	CIVIL ENGINEERING	CIV	INF
CIV	CIVIL ENGINEERING	CIV	GIN
CIV	CIVIL ENGINEERING	CIV	CVT
CME	COMPUTER ENGINEERING	CSE	CSE
CME	COMPUTER ENGINEERING	CSE	CSS
CME	COMPUTER ENGINEERING	CSE	ECM
CME	COMPUTER ENGINEERING	CSE	INF
CME	COMPUTER ENGINEERING	CSE	CST
COT	CHEMICAL(OIL TECHNOLOGY) ENGINEERING(3 1/2 YR)	CHE	CHE
COT	CHEMICAL(OIL TECHNOLOGY) ENGINEERING(3 1/2 YR)	CHE	CPE
COT	CHEMICAL(OIL TECHNOLOGY) ENGINEERING(3 1/2 YR)	CHE	CSE
COT	CHEMICAL(OIL TECHNOLOGY) ENGINEERING(3 1/2 YR)	CHE	INF
COT	CHEMICAL(OIL TECHNOLOGY) ENGINEERING(3 1/2 YR)	CHE	PET
CPC	CHEMICAL(PETROCHEMICAL) ENGINEERING (3 1/2 YR)	CHE	CHE
CPC	CHEMICAL(PETROCHEMICAL) ENGINEERING (3 1/2 YR)	CHE	CPE
CPC	CHEMICAL(PETROCHEMICAL) ENGINEERING (3 1/2 YR)	CHE	CSE
CPC	CHEMICAL(PETROCHEMICAL) ENGINEERING (3 1/2 YR)	CHE	INF
CPC	CHEMICAL(PETROCHEMICAL) ENGINEERING (3 1/2 YR)	CHE	PET
CPP	CHEMICAL(PLASTICS&POLYMERS) ENGINEERING(3 1/2 YR)	CHE	CHE
CPP	CHEMICAL(PLASTICS&POLYMERS) ENGINEERING(3 1/2 YR)	CHE	CPE
CPP	CHEMICAL(PLASTICS&POLYMERS) ENGINEERING(3 1/2 YR)	CHE	CSE
CPP	CHEMICAL(PLASTICS&POLYMERS) ENGINEERING(3 1/2 YR)	CHE	INF
CPP	CHEMICAL(PLASTICS&POLYMERS) ENGINEERING(3 1/2 YR)	CHE	PET
CST	CHEMICAL ENGINEERING IN SUGAR TECHNOLOGY	CHE	CHE
CST	CHEMICAL ENGINEERING IN SUGAR TECHNOLOGY	CHE	CPE
CST	CHEMICAL ENGINEERING IN SUGAR TECHNOLOGY	CHE	CSE
CST	CHEMICAL ENGINEERING IN SUGAR TECHNOLOGY	CHE	INF
CST	CHEMICAL ENGINEERING IN SUGAR TECHNOLOGY	CHE	PET
ECE	ELECTRONICS AND COMMUNICATION	ECE	CSE

	ENGINEERING		
ECE	ELECTRONICS AND COMMUNICATION ENGINEERING	ECE	ECE
ECE	ELECTRONICS AND COMMUNICATION ENGINEERING	ECE	ECS
ECE	ELECTRONICS AND COMMUNICATION ENGINEERING	ECE	ETM
ECE	ELECTRONICS AND COMMUNICATION ENGINEERING	ECE	INF
ECE	ELECTRONICS AND COMMUNICATION ENGINEERING	ECE	ETC
ECM	ELECTRONICS AND COMPUTERS ENGINEERING	CSE	CSE
ECM	ELECTRONICS AND COMPUTERS ENGINEERING	CSE	CSS
ECM	ELECTRONICS AND COMPUTERS ENGINEERING	CSE	ECM
ECM	ELECTRONICS AND COMPUTERS ENGINEERING	CSE	INF
EEE	ELECTRICAL AND ELECTRONICS ENGINEERING	EEE	CSE
EEE	ELECTRICAL AND ELECTRONICS ENGINEERING	EEE	EEE
EEE	ELECTRICAL AND ELECTRONICS ENGINEERING	EEE	INF
EEE	ELECTRICAL AND ELECTRONICS ENGINEERING	EEE	PWR
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	ECE	CSE
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	ECE	ECE
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	ECE	ECS
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	ECE	ETM
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	ECE	INF
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	ECE	ETC
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	EIE	AEI
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	EIE	CSE
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	EIE	EIE
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	EIE	ICE
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	EIE	INF
EIE	ELECTRONICS INSTRUMENTATION ENGINEERING	EIE	IST
EMB	SPL.DIP.IN ELECTRONICS(EMBEDDED SYSTEMS)(3 1/2 YR)	ECE	CSE
EMB	SPL.DIP.IN ELECTRONICS(EMBEDDED SYSTEMS)(3 1/2 YR)	ECE	ECE
EMB	SPL.DIP.IN ELECTRONICS(EMBEDDED SYSTEMS)(3 1/2 YR)	ECE	ECS
EMB	SPL.DIP.IN ELECTRONICS(EMBEDDED SYSTEMS)(3 1/2 YR)	ECE	ETM
EMB	SPL.DIP.IN ELECTRONICS(EMBEDDED SYSTEMS)(3 1/2 YR)	ECE	INF
EMB	SPL.DIP.IN ELECTRONICS(EMBEDDED SYSTEMS)(3 1/2 YR)	ECE	ETC
FWT	FOOTWEAR TECHNOLOGY(3 1/2 YR)	MEC	ANE
FWT	FOOTWEAR TECHNOLOGY(3 1/2 YR)	MEC	AUT
FWT	FOOTWEAR TECHNOLOGY(3 1/2 YR)	MEC	CSE
FWT	FOOTWEAR TECHNOLOGY(3 1/2 YR)	MEC	INF
FWT	FOOTWEAR TECHNOLOGY(3 1/2 YR)	MEC	IPE
FWT	FOOTWEAR TECHNOLOGY(3 1/2 YR)	MEC	MCT
FWT	FOOTWEAR TECHNOLOGY(3 1/2 YR)	MEC	MEC
FWT	FOOTWEAR TECHNOLOGY(3 1/2 YR)	MEC	NMA
INE	INDUSTRIAL ENGINEERING	MEC	CSE
INE	INDUSTRIAL ENGINEERING	MEC	INF
INE	INDUSTRIAL ENGINEERING	MEC	ANE
INE	INDUSTRIAL ENGINEERING	MEC	ASE
INE	INDUSTRIAL ENGINEERING	MEC	AUT

INE	INDUSTRIAL ENGINEERING	MEC	IPE
INE	INDUSTRIAL ENGINEERING	MEC	MCT
INE	INDUSTRIAL ENGINEERING	MEC	MEC
INE	INDUSTRIAL ENGINEERING	MEC	NMA
INE	INDUSTRIAL ENGINEERING	MIN	MME
INE	INDUSTRIAL ENGINEERING	MIN	CSE
INE	INDUSTRIAL ENGINEERING	MIN	INF
INF	INFORMATION TECHNOLOGY	CSE	CSE
INF	INFORMATION TECHNOLOGY	CSE	CSS
INF	INFORMATION TECHNOLOGY	CSE	ECM
INF	INFORMATION TECHNOLOGY	CSE	INF
INF	INFORMATION TECHNOLOGY	CSE	CST
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MEC	CSE
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MEC	INF
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MEC	ANE
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MEC	ASE
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MEC	AUT
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MEC	IPE
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MEC	MCT
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MEC	MEC
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MEC	NMA
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MIN	MME
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MIN	CSE
IPE	INDUSTRIAL PRODUCTION ENGINEERING	MIN	INF
JDM	JEWELLERY DESIGN AND MANUFACTURING	MEC	ANE
JDM	JEWELLERY DESIGN AND MANUFACTURING	MEC	AUT
JDM	JEWELLERY DESIGN AND MANUFACTURING	MEC	CSE
JDM	JEWELLERY DESIGN AND MANUFACTURING	MEC	INF
JDM	JEWELLERY DESIGN AND MANUFACTURING	MEC	IPE
JDM	JEWELLERY DESIGN AND MANUFACTURING	MEC	MCT
JDM	JEWELLERY DESIGN AND MANUFACTURING	MEC	MEC
JDM	JEWELLERY DESIGN AND MANUFACTURING	MEC	NMA
LT	LEATHER TECHNOLOGY (3 1/2 YR)	CHE	CHE
LT	LEATHER TECHNOLOGY (3 1/2 YR)	CHE	CPE
LT	LEATHER TECHNOLOGY (3 1/2 YR)	CHE	CSE
LT	LEATHER TECHNOLOGY (3 1/2 YR)	CHE	INF
MEC	MECHANICAL ENGINEERING	MEC	ANE
MEC	MECHANICAL ENGINEERING	MEC	AUT
MEC	MECHANICAL ENGINEERING	MEC	CSE
MEC	MECHANICAL ENGINEERING	MEC	INF
MEC	MECHANICAL ENGINEERING	MEC	IPE
MEC	MECHANICAL ENGINEERING	MEC	MCT
MEC	MECHANICAL ENGINEERING	MEC	MEC
MEC	MECHANICAL ENGINEERING	MEC	NMA
MEC	MECHANICAL ENGINEERING	MEC	ASE
MEC	MECHANICAL ENGINEERING	MEC	MNT
MEC	MECHANICAL ENGINEERING	MIN	MME
MET	METALLURGICAL ENGINEERING(3 1/2 YR)	MET	CSE
MET	METALLURGICAL ENGINEERING(3 1/2 YR)	MET	INF
MET	METALLURGICAL ENGINEERING(3 1/2 YR)	MET	MET
MET	METALLURGICAL ENGINEERING(3 1/2 YR)	MET	MMT
MIN	MINING ENGINEERING	MIN	CSE
MIN	MINING ENGINEERING	MIN	INF
MIN	MINING ENGINEERING	MIN	MIN
MIN	MINING ENGINEERING	MIN	MME

MSW	MECHANICAL(SANDWICH) ENGINEERING(3 1/2 YR)	MEC	ANE
MSW	MECHANICAL(SANDWICH) ENGINEERING(3 1/2 YR)	MEC	AUT
MSW	MECHANICAL(SANDWICH) ENGINEERING(3 1/2 YR)	MEC	CSE
MSW	MECHANICAL(SANDWICH) ENGINEERING(3 1/2 YR)	MEC	INF
MSW	MECHANICAL(SANDWICH) ENGINEERING(3 1/2 YR)	MEC	IPE
MSW	MECHANICAL(SANDWICH) ENGINEERING(3 1/2 YR)	MEC	MCT
MSW	MECHANICAL(SANDWICH) ENGINEERING(3 1/2 YR)	MEC	MEC
MSW	MECHANICAL(SANDWICH) ENGINEERING(3 1/2 YR)	MEC	NMA
MSW	MECHANICAL(SANDWICH) ENGINEERING(3 1/2 YR)	MEC	ASE
PHM	PHARMACY	BIO	BIO
PHM	PHARMACY	PHM	PHM
PKT	PACKAGING TECHNOLOGY	MEC	ANE
PKT	PACKAGING TECHNOLOGY	MEC	AUT
PKT	PACKAGING TECHNOLOGY	MEC	CSE
PKT	PACKAGING TECHNOLOGY	MEC	INF
PKT	PACKAGING TECHNOLOGY	MEC	IPE
PKT	PACKAGING TECHNOLOGY	MEC	MCT
PKT	PACKAGING TECHNOLOGY	MEC	MEC
PKT	PACKAGING TECHNOLOGY	MEC	NMA
PT	PRINTING TECHNOLOGY	MEC	ANE
PT	PRINTING TECHNOLOGY	MEC	AUT
PT	PRINTING TECHNOLOGY	MEC	CSE
PT	PRINTING TECHNOLOGY	MEC	INF
PT	PRINTING TECHNOLOGY	MEC	IPE
PT	PRINTING TECHNOLOGY	MEC	MCT
PT	PRINTING TECHNOLOGY	MEC	MEC
PT	PRINTING TECHNOLOGY	MEC	NMA
SCN	SPL.DIP.IN ELECTRONICS (COMMUNICATION) ENGG.(3 1/2	ECE	CSE
SCN	SPL.DIP.IN ELECTRONICS (COMMUNICATION) ENGG.(3 1/2	ECE	ECE
SCN	SPL.DIP.IN ELECTRONICS (COMMUNICATION) ENGG.(3 1/2	ECE	ECS
SCN	SPL.DIP.IN ELECTRONICS (COMMUNICATION) ENGG.(3 1/2	ECE	ETM
SCN	SPL.DIP.IN ELECTRONICS (COMMUNICATION) ENGG.(3 1/2	ECE	INF
SCN	SPL.DIP.IN ELECTRONICS (COMMUNICATION) ENGG.(3 1/2	ECE	ETC
SCP	SPL.DIP.IN ELECTRONICS (COMPUTER)ENGINEERING(3 1/2	CSE	CSE
SCP	SPL.DIP.IN ELECTRONICS (COMPUTER)ENGINEERING(3 1/2	CSE	CSS
SCP	SPL.DIP.IN ELECTRONICS (COMPUTER)ENGINEERING(3 1/2	CSE	ECM
SCP	SPL.DIP.IN ELECTRONICS (COMPUTER)ENGINEERING(3 1/2	CSE	INF
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3	ECE	CSE

	1/2 YR		
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	ECE	ECE
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	ECE	ECS
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	ECE	ETM
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	ECE	INF
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	ECE	ETC
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	EIE	AEI
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	EIE	CSE
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	EIE	EIE
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	EIE	ICE
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	EIE	INF
SEI	SPL.DIP.IN ELECTRONICS (INDUSTRIAL ELECT)(3 1/2 YR	EIE	IST
TVS	SPL.DIP.IN ELECTRONICS (TV&SOUND)ENGINEERING (3 1/	ECE	CSE
TVS	SPL.DIP.IN ELECTRONICS (TV&SOUND)ENGINEERING (3 1/	ECE	ECE
TVS	SPL.DIP.IN ELECTRONICS (TV&SOUND)ENGINEERING (3 1/	ECE	ECS
TVS	SPL.DIP.IN ELECTRONICS (TV&SOUND)ENGINEERING (3 1/	ECE	ETM
TVS	SPL.DIP.IN ELECTRONICS (TV&SOUND)ENGINEERING (3 1/	ECE	INF
TVS	SPL.DIP.IN ELECTRONICS (TV&SOUND)ENGINEERING (3 1/	ECE	ETC
TXT	TEXTILE TECHNOLOGY(SANDWICH,KNITTING,DESIGN AND MANUF)	CHE	CHE
TXT	TEXTILE TECHNOLOGY(SANDWICH,KNITTING,DESIGN AND MANUF)	CHE	CPE
TXT	TEXTILE TECHNOLOGY(SANDWICH,KNITTING,DESIGN AND MANUF)	CHE	CSE
TXT	TEXTILE TECHNOLOGY(SANDWICH,KNITTING,DESIGN AND MANUF)	CHE	INF
TXT	TEXTILE TECHNOLOGY(SANDWICH,KNITTING,DESIGN AND MANUF)	CHE	TEX
ETM	ELECTRONICS AND TELEMATICS	ECE	CSE
ETM	ELECTRONICS AND TELEMATICS	ECE	ECE
ETM	ELECTRONICS AND TELEMATICS	ECE	ECS
ETM	ELECTRONICS AND TELEMATICS	ECE	ETM
ETM	ELECTRONICS AND TELEMATICS	ECE	INF
ETM	ELECTRONICS AND TELEMATICS	ECE	ETC